

## Class G and NASA Space-Grade Guidelines

## NASA and Class G Screening

The MIL-DTL-38999 specification defines TML and CVCN values for Class G space flight. Glenair modification code 186T assures parts are outgassed to meet the Class G requirements for outgassing.

Additionally, NASA recommends that connectors for space flight be specially screened. NASA EEE-INST-002 instructions for EEE parts selection, screening, qualification, and derating contains three levels of screening for space-grade components. These outgassing and screening modification codes are listed at right. To add a modification code append code to end of part number: 233-219-G6ME11-1AN-429C.

- **“Mission critical” connectors for space flight should undergo rigorous 100% final inspection**
- **Modification codes are available to invoke special screening for both MIL-DTL-38999 and NASA applications**
- **Outgassing properties of materials used in Glenair SuperNine® connectors are detailed in the table below**

## Screening Level and Available Outgassing Modification Codes

Screening Level	Screening Only	48 Hour Oven Bake 175° C	Thermal Vacuum Outgassing (10 <sup>-6</sup> Torr)	
			24 Hour 125° C	48 Hour 175° C
NASA, Level 1 Highest Reliability	429B	429J	429C	
NASA, Level 2 High Reliability	429	429K	429A	429AA
NASA, Level 3 Standard Reliability	Use Standard Part Number		429L	
38999, Class G or H (Group A and B inspection, no screening)				186T

Table II: NASA EEE-INST-02, Table 2A Screening Levels

Inspection	Level 1	Level 2	Level 3
Visual	100%	100%	100%
Mechanical	2(0)	2(0)	
Dielectric Withstanding Voltage	2(0)	2(0)	
Insulation Resistance	2(0)	2(0)	
Contact Engagement & Separation Force	2(0)		
Hermeticity (Sealed Receptacles Only)	100%	100%	
Coupling Force	2(0)		

Required inspection quantity shown. Number in parenthesis indicates acceptance of failures allowed for all quantities inspected.

## Outgassing Properties of Materials Used in MIL-DTL-38999 Type SuperNine® Connectors

Component	Material	TML %	CVCN %	Test Reference
Front and Rear Insulator	Epiall 1908	0.84	0.0	NASA Test # GSC15435 (48 hours at 180°C)
Rear Grommet, Interfacial Seal, Peripheral Seal, and Special Auxiliary Seals	Blended fluorosilicone/silicone elastomer	0.04	0.0	Glenair test
Front-to-Rear Insulator Bonding Material	Eccobond 104 A/B	0.52	0.08	Emerson & Cuming Data Sheet
Insulator-to-Rubber Bonding Material	RTV, per MIL-A-46146	<1.0	<0.1	Glenair Test
White Epoxy Ink for Silk-screening	Markem 7224 White	0.49	0.03	NASA Test #GSC19899
Potting Compound	High-performance space-grade epoxy	<1.0	<0.1	Glenair Test

## MIL-DTL-38999 Type SuperNine® Connector Materials Approved for Space Flight

Component	Material	Notes
Shells, Coupling Nuts, Jam Nuts	Aluminum alloy	Approved for Space Flight
Rigid Insulators	Glass reinforced thermoset plastic, Epiall 1908	Approved for Space Flight
Contact Retention Clip	Beryllium copper, heat-treated, unplated	Approved for Space Flight
Grommet, Peripheral Seal, Interfacial Seal, Special Auxiliary Seals, O-ring	Blended fluorosilicone/silicone elastomer	Requires outgassing processing
Pin/Socket Contact	Gold plated beryllium copper alloy	Approved for Space Flight
Socket Contact Hood	Stainless steel	Approved for Space Flight
Potting Compounds and Adhesives	RTV and epoxies	Requires outgassing processing